

1 Substrate: 0.0625"±0.007" FR4/G10 or equivalent high temp material. 1/2 oz. Cu clad. SnPb plating

2 Substrate: 0.125"±0.007" FR4/G10 or equivalent high temp material. Non-clad


3 Pins: Material- Brass Alloy 360 1/2 hard; finish- 10µ" Au over 50µ" Ni (min.).

4 Pins: shell material- Brass Alloy 360 1/2 hard; finish- 10µ" Au over 50µ" Ni (min.). Contact material- BeCu; finish 10µ" Au over 100µ" Ni (min.)

Description: TSOP Land Socket

56 position surface mount land pattern to 56 pin leadless surface mountable foot. CA-SO56F-L-S-01 is compatible with C2702 .

All tolerances: ±0.005" (unless stated otherwise). Materials and specifications are subject to change without notice.

CA-SO56F-L-S-01 Drawing		Status: Released	Scale: 5:1	Rev: A
 <p>© 1999 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com</p>	Drawing: E Smolentseva		Date: 06/04/99	
	File: CA-SO56F-L-S-01 Dwg		Modified:	